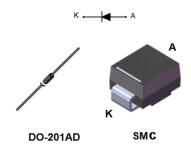


1000 V - 3 A high efficiency ultrafast diode



Features

- · Low forwarded voltage drop
- · High reliability
- · High surge current capability
- · Soft switching for reduced EMI disturbances
- Planar technology
- ECOPACK2 compliant

Applications

- · Switching diode
- · Auxiliary power supply

Description

The STTH310, which uses ST ultrafast high voltage planar technology, is specially suited for free-wheeling, clamping, snubbering, demagnetization in power supplies and other power switching applications.

Product status
STTH310

Product summary						
Symbol Value						
I _{F(AV)}	3 A					
V _{RRM}	1000 V					
T _{j(max.)}	175 °C					
$V_{F(typ.)}$	0.98 V					
t _{rr(max.)}	75 ns					



1 Characteristics

Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Paramet	Value	Unit			
V _{RRM}	Repetitive peak reverse voltage	Repetitive peak reverse voltage				
	Average feminard average \$ = 0.5 carvage views	DO-201AD T _L = 75 °C		2		
I _{F(AV)}	Average forward current δ = 0.5, square wave	SMC	T _L = 75 °C	3	A	
1	Course and an extension of an usual surround	DO-201AD	t = 9.2 mg sinussidal	55		
IFSM	I _{FSM} Surge non repetitive forward current		t _p = 8.3 ms sinusoidal	45	Α	
T _{stg}	Storage temperature range	-65 to +175	°C			
Tj	Maximum operating junction temperature	+175	°C			

Table 2. Thermal resistance parameter

Symbol		Max. value	Unit		
Par a s	Junction to lead		SMC	20	
R _{th(j-l)}	Junction to lead	Load longth = 10 mm	DO 201AD	20	°C/W
R _{th(j-a)}	Junction to ambient	Lead length = 10 mm	DO-201AD	75	

For more information, please refer to the following application note:

• AN5088 : Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I_ (1)	L (1)		V - V	-		10	
IR ^(*)	I _R ⁽¹⁾ Reverse leakage current	T _j = 125 °C	$V_R = V_{RRM}$	-		50	μA
V _E ⁽²⁾	Fanuard valtage drap	T _j = 25 °C	I _E = 3 A	-		1.7	V
v F ⁽⁻⁾	V _F ⁽²⁾ Forward voltage drop		IF - 3 A	-	0.98	1.42	V

- 1. Pulse test: $t_p = 5$ ms, $\delta < 2\%$
- 2. Pulse test: t_p = 380 μ s, δ < 2%

To evaluate the conduction losses, use the following equation:

$$P = 1.20 \times I_{F(AV)} + 0.075 \times I_{F^{2}(RMS)}$$

For more information, please refer to the following application notes related to the power losses :

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

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Table 4. Dynamic characteristics (T_j = 25 °C unless otherwise stated)

Symbol	Parameters	Test conditions		Тур.	Max.	Unit
t _{rr}	Reverse recovery time	$I_F = 0.5 \text{ A}, I_{rr} = 0.25 \text{ A}, I_R = 1 \text{ A}$	-	-	75	ns
t _{fr}	Forward recovery time	I _F = 3 A, dI _F /dt = 50 A/μs, V _{FR} = 1.1 V _{F(max.)}		-	300	ns
V _{FP}	Forward recovery voltage	1 3 Λ, αιε/αι - 30 Λ/μ3, VFR - 1.1 VF(max.)	-	-	12	V

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1.1 **Characteristics (curves)**

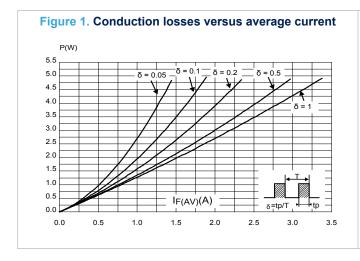
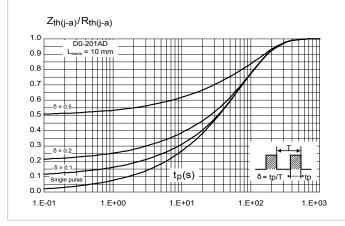


Figure 2. Forward voltage drop versus forward current I_{FM}(A) 100.0 T_j=150°C maximum val 10.0 $V_{FM}(V)$ 2.5 0.0 0.5 1.0 2.0 3.0

Figure 3. Relative variation of thermal impedance junction | Figure 4. Relative variation of thermal impedance junction to ambient versus pulse duration (DO-201AD)



to ambient versus pulse duration(SMC)

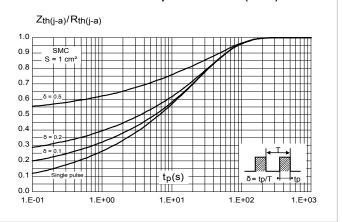


Figure 5. Thermal resistance versus lead length (DO-201AD)

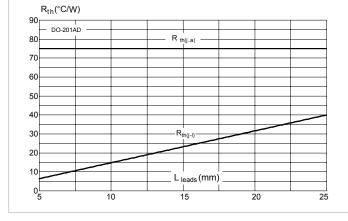
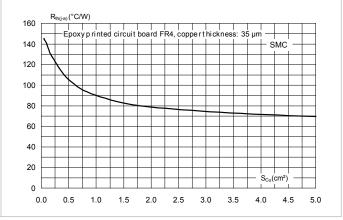


Figure 6. Thermal resistance junction to ambient versus copper surface under each lead (typical values) (SMC)



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Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 DO-201AD package information

Epoxy meets UL 94, V0

B A B

Note 1 P Note 1

Note 2

Figure 7. DO-201AD package outline

Table 5. DO-201AD package mechanical data

	Dimensions						
Ref.	Millimeters			Inch	es (for reference	only)	
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А		-	9.50		-	0.374	
В	25.40	-		1.000	-		
С		-	5.30		-	0.209	
D ⁽¹⁾		-	1.30		-	0.051	
E		-	1.25			0.049	
Note 2 ⁽²⁾	15.00			0.590			

^{1.} The lead diameter D is not controlled over zone E

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^{2.} The minimum length, which must stay straight between the right angles after bending, is 15 mm (0.59")



2.2 SMC package information

• Epoxy meets UL94, V0

Figure 8. SMC package outline

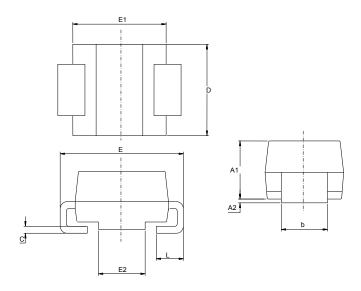


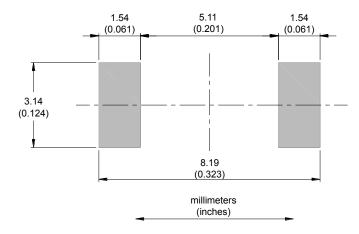
Table 6. SMC package mechanical data

	Dimensions					
Ref.	Millin	neters	Inches (for reference only)			
	Min.	Max.	Min.	Max.		
A1	1.90	2.45	0.0748	0.0965		
A2	0.05	0.20	0.0020	0.0079		
b	2.90	3.20	0.1142	0.1260		
С	0.15	0.40	0.0059	0.0157		
D	5.55	6.25	0.2185	0.2461		
E	7.75	8.15	0.3051	0.3209		
E1	6.60	7.15	0.2598	0.2815		
E2	4.40	4.70	0.1732	0.1850		
L	0.75	1.50	0.0295	0.0591		

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Figure 9. SMC recommended footprint



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3 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STTH310S	S10	SMC	0.245 g	2500	Tape and reel
STTH310	STTH310	DO-201AD	1.16 g	600	Ammopack
STTH310RL	STTH310	DO-201AD	1.16 g	1900	Tape and reel

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Revision history

Table 8. Document revision history

Date	Revision	Changes
Jan-2003	1	Initial release.
03-Apr-2007	2	DO-201AD C2 package added. SMC package information updated.
07-Dec-2009	3	Updated Table 6 package dimensions.
21-Jun-2012	4	Updated T _j in Table 1 and Table 2 and change min. T _{stg} to -65 °C in Table 2.
31-Mar-2020	5	Updated Figure 4, Figure 5 and Figure 6.
31-Wai-2020	3	Reformatted to current standard.

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